



2.5Ω, Low-Voltage, SPST/SPDT Analog Switches in UCSP Package

General Description

The MAX4686/MAX4687/MAX4688 low on-resistance (R_{ON}), low-voltage analog switches operate from a single +1.8V to +5.5V supply. The MAX4686/MAX4687 are single-pole/single-throw (SPST) analog switches, and the MAX4688 is a single-pole/double-throw (SPDT) analog switch. The MAX4686 is a normally open (NO) switch, and the MAX4687 is a normally closed (NC) switch. The MAX4688 has one normally open (NO) switch and one normally closed (NC) switch.

When powered from a 3V supply these devices feature 2.5Ω (max) R_{ON} , with 0.4Ω (max) R_{ON} matching and 1Ω (max) flatness. The MAX4686/MAX4687/MAX4688 offer fast switching speeds (t_{ON} = 30ns max, t_{OFF} = 12ns max). The MAX4688 offers break-before-make action.

The digital logic inputs are 1.8V logic compatible from a +2.7V to +3.3V supply. The MAX4686/MAX4687/MAX4688 are available in the chip-scale package (UCSP™), significantly reducing the required PC board area. The chip occupies only a 1.50mm x 1.02mm area. The 3 x 2 array of solder bumps are spaced with a 0.5mm bump pitch.

Applications

MP3 Players
Cellular Phones
Power Routing
Battery-Operated Equipment
Relay Replacement
Audio and Video Signal Routing
Communications Circuits
PCMCIA Cards
Cellular Phones
Hard Drives

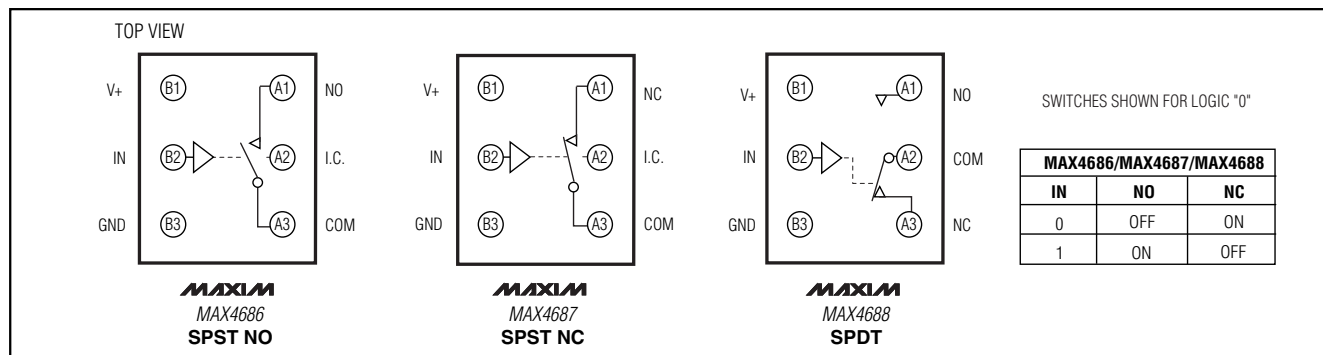
Features

- ◆ 6-Bump, 0.5mm Pitch, UCSP
- ◆ R_{ON}
2.5Ω max (+3V Supply)
10Ω max (+1.8V Supply)
- ◆ 0.4Ω max R_{ON} Match Between Channels
- ◆ 1Ω max R_{ON} Flatness Over Signal Range
- ◆ Low Leakage Currents Over Temperature
0.5nA (max) at T_A = +25°C
- ◆ Fast Switching: t_{ON} = 30ns, t_{OFF} = 12ns
- ◆ Guaranteed Break-Before-Make (MAX4688)
- ◆ +1.8V to +5.5V Single-Supply Operation
- ◆ Rail-to-Rail® Signal Handling
- ◆ Low Crosstalk: -95dB (100kHz)
- ◆ High Off-Isolation: -90dB (100kHz)
- ◆ 1.8V Logic Compatible

Ordering Information

PART	TEMP RANGE	BUMP-PACKAGE	TOP MARK
MAX4686EBT-T	-40°C to +85°C	6 UCSP-6	AAI
MAX4687EBT-T	-40°C to +85°C	6 UCSP-6	AAJ
MAX4688EBT-T	-40°C to +85°C	6 UCSP-6	AAK

Pin Configurations/Functional Diagrams/Truth Table



Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.

UCSP is a trademark of Maxim Integrated Products, Inc.



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ABSOLUTE MAXIMUM RATINGS

All Voltages Referenced to GND

V+, IN -0.3V to +6V
 COM, NO, NC (Note1) -0.3V to (V+ + 0.3V)
 Continuous Current NO, NC, COM $\pm 100\text{mA}$
 Peak Current NO, NC, COM
 (pulsed at 1ms, 10% duty cycle) $\pm 200\text{mA}$

Continuous Power Dissipation ($T_A = +70^\circ\text{C}$)

3 x 2 UCSP (derate 10.1mW/ $^\circ\text{C}$ at $+70^\circ\text{C}$) 808mW

Operating Temperature Range -40°C to $+85^\circ\text{C}$

Storage Temperature Range -65°C to $+150^\circ\text{C}$

Bump Reflow Temperature $+235^\circ\text{C}$

Note 1: Signals on NO, NC, and COM exceeding V+ are clamped by an internal diode. Limit forward-diode current to maximum current rating.

Note 2: This device is constructed using a unique set of packaging techniques that impose a limit on the thermal profile the device can be exposed to during board level solder attach and rework. This limit permits only the use of the solder profiles recommended in the industry standard specification, JEDEC 020A, paragraph 7.6, Table 3 for IR/VPR and convection reflow. Preheating is required. Hand or wave soldering is not allowed.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V+ = +2.7V to +3.3V, $V_{IH} = +1.4\text{V}$, $V_{IL} = 0.5\text{V}$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at 3V and $T_A = +25^\circ\text{C}$.) (Notes 3, 4)

PARAMETER	SYMBOL	CONDITIONS	T _A	MIN	TYP	MAX	UNITS
ANALOG SWITCH							
Analog Signal Range	V _{COM} , V _{NO} , V _{NC}		T _{MIN} to T _{MAX}	0		V+	V
On-Resistance	R _{ON}	V+ = 2.7V, V _{NC} = 0 to V+, I _{COM} = 10mA	+25°C	1.5	2.5	Ω	
			T _{MIN} to T _{MAX}	3.5			
On-Resistance Match Between Channels (MAX4688 only) (Note 5)	ΔR _{ON}	V+ = 2.7V, V _{NO} or V _{NC} = 1.5V, I _{COM} = 10mA	+25°C	0.3	0.4	Ω	
			T _{MIN} to T _{MAX}	0.5			
On-Resistance Flatness (Note 6)	R _{FLAT(ON)}	V+ = 2.7V, V _{NO} or V _{NC} = 0 to V+, I _{COM} = 10mA	+25°C	0.5	1	Ω	
			T _{MIN} to T _{MAX}	1			
NO, NC Off-Leakage Current (Note 7)	I _{NO(OFF)} , I _{NC(OFF)}	V+ = 3.3V; V _{COM} = 0.3V or 3V; V _{NO} or V _{NC} = 3V, 0.3V	+25°C	-0.5	±0.01	+0.5	nA
			T _{MIN} to T _{MAX}	-1	1		
COM Off-Leakage Current (Note 7)	I _{COM_(OFF)}	V+ = 3.3V; V _{COM} = 0.3V or 3V; V _{NO} or V _{NC} = 3V, 0.3V	+25°C	-0.5	±0.01	0.5	nA
			T _{MIN} to T _{MAX}	-1	1		
COM On-Leakage Current (Note 7)	I _{COM_(ON)}	V+ = 3.3V; V _{COM} = 3V or 0.3V; V _{NO} or V _{NC} = 3V, 0.3V, or floating	+25°C	-0.5	±0.01	0.5	nA
			T _{MIN} to T _{MAX}	-1	1		
DYNAMIC CHARACTERISTICS							
Turn-On Time (Note 7)	t _{ON}	V _{NO} or V _{NC} = 1.5V, Figure 2	+25°C	20	30	ns	
			T _{MIN} to T _{MAX}	35			

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ELECTRICAL CHARACTERISTICS (continued)

(V+ = +2.7V to +3.3V, V_{IH} = +1.4V, V_{IL} = 0.5V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at 3V and T_A = +25°C.)
(Notes 3, 4)

PARAMETER	SYMBOL	CONDITIONS	T _A	MIN	TYP	MAX	UNITS
Turn-Off Time (Note 7)	t _{OFF}	V _{NO} or V _{NC} = 1.5V, Figure 2	+25°C		10	12	ns
			T _{MIN} to T _{MAX}			15	
Break-Before-Make (MAX4688 only) (Note 7)	t _{BBM}	V _{NO} , V _{NC} = 1.5V, Figure 3	+25°C		8		ns
			T _{MIN} to T _{MAX}	2			
Charge Injection	Q	V _{GEN} = 0, R _{GEN} = 0, C _L = 1.0nF, Figure 4	+25°C		40		pC
On-Channel -3dB Bandwidth	BW	Signal = 0dBm, 50Ω in and out, Figure 5	+25°C		200		MHz
Off-Isolation (Note 8)	V _{ISO}	C _L = 5pF, R _L = 50Ω, f = 100kHz, Figure 5	+25°C		-90		dB
Crosstalk (MAX4688 only) (Note 9)	V _{CR}	C _L = 5pF, R _L = 50Ω, f = 100kHz, Figure 5	+25°C		-95		dB
Total Harmonic Distortion	THD	R _L = 600Ω, 2Vp-p, f = 20Hz to 20kHz	+25°C		0.06		%
NO, NC Off- Capacitance	C _{NO(OFF)} , C _{NC(OFF)}	f = 1MHz, Figure 6	+25°C		12		pF
COM Off-Capacitance	C _{COM(OFF)}	f = 1MHz, Figure 6	+25°C		12		pF
Switch On-Capacitance	C _(ON)	f = 1MHz, Figure 6	+25°C		35		pF
DIGITAL I/O							
Input Logic High	V _{IH}		T _{MIN} to T _{MAX}	1.4			V
Input Logic Low	V _{IL}		T _{MIN} to T _{MAX}			0.5	V
Logic Input Leakage Current	I _{IH} , I _{IL}	V _{IN} = 0 or V+	T _{MIN} to T _{MAX}	-1		1	μA
POWER SUPPLY							
Power-Supply Range	V+		T _{MIN} to T _{MAX}	1.8		5.5	V
Supply Current	I+	V+ = 3.3V, V _{IN} = 0 or V+	T _{MIN} to T _{MAX}	-1		1	μA

Note 3: The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.

Note 4: UCSP parts are 100% tested at +25°C only and guaranteed by correlation at the full hot-rated temperature.

Note 5: ΔRON = RON(MAX) - RON(MIN), between switches.

Note 6: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

Note 7: Guaranteed by design.

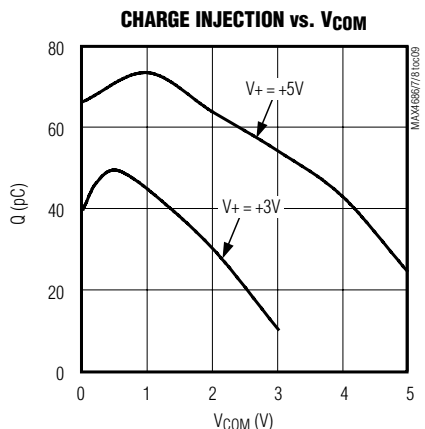
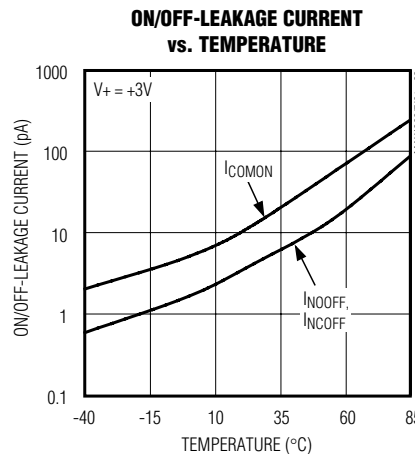
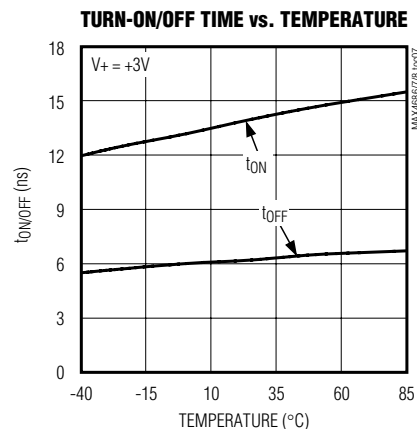
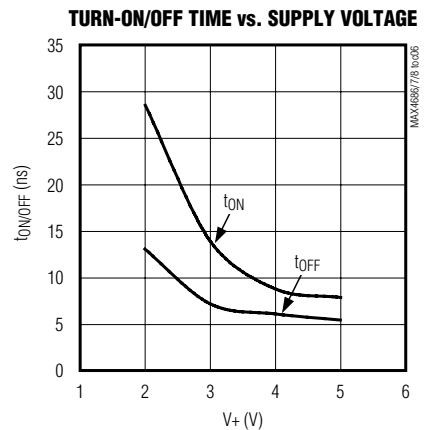
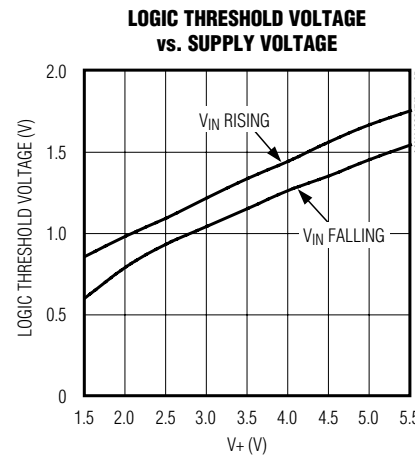
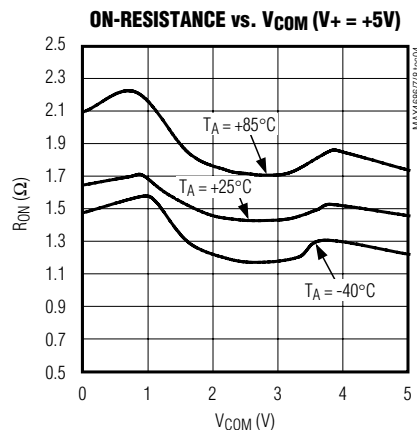
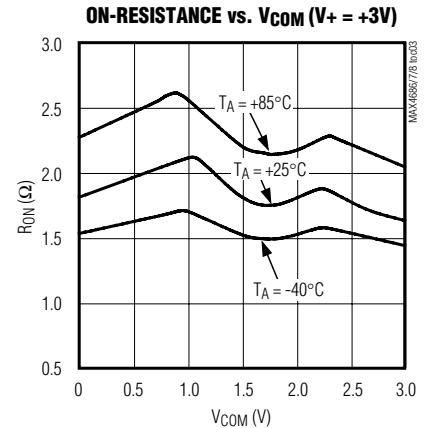
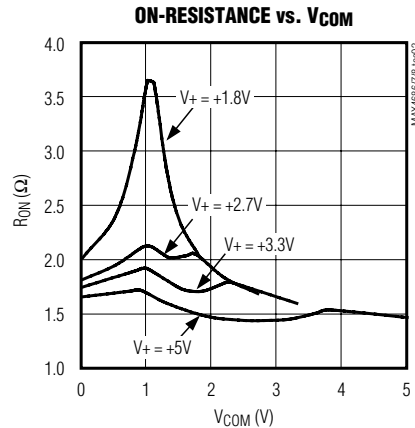
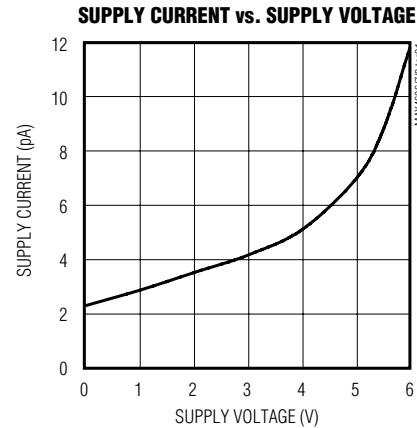
Note 8: Off Isolation = 20log₁₀ (V_{COM} / V_{NO}), V_{COM} = output, V_{NO} = input to off switch.

Note 9: Between switches.

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Typical Operating Characteristics

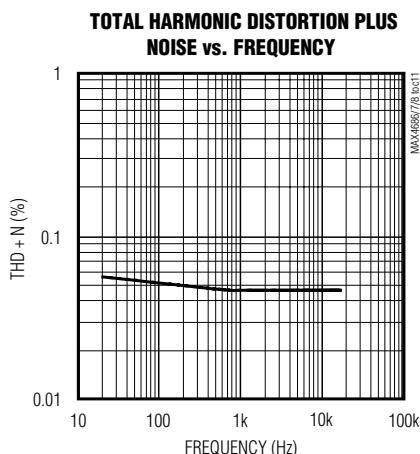
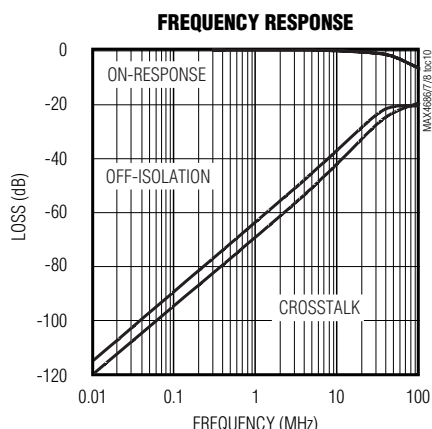
($T_A = +25^\circ\text{C}$, unless otherwise noted.)



2.5Ω, Low-Voltage, SPST/SPDT Analog Switches in UCSP Package

Typical Operating Characteristics (continued)

(T_A = +25°C, unless otherwise noted.)



Pin Description

BUMP			NAME	FUNCTION
MAX4686	MAX4687	MAX4688		
B1	B1	B1	V+	Positive Supply Voltage Input
B2	B2	B2	IN	Digital Control Input
B3	B3	B3	GND	Ground
—	A1	A3	NC	Analog Switch, Normally Closed Terminal
A3	A3	A2	COM	Analog Switch, Common Terminal
A1	—	A1	NO	Analog Switch, Normally Open Terminal
A2	A2	—	I.C.	Internally Connected

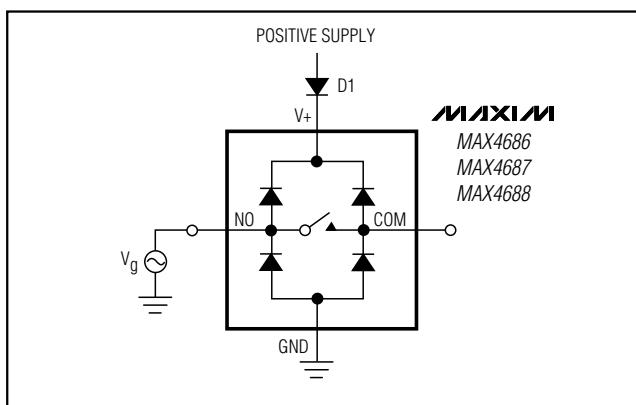


Figure 1. Overvoltage Protection Using External Blocking Diodes

Applications Information

Logic Inputs

Where the MAX4686/MAX4687/MAX4688 have a +3.3V supply, IN may be driven low to GND and driven high to 5.5V. Driving IN rail-to-rail minimizes power consumption. Logic inputs accept up to +5.5V regardless of supply voltage.

Analog Signal Levels

Analog signals that range over the entire supply voltage (V+ to GND) are passed with very little change in R_{ON} (see *Typical Operating Characteristics*). The switches are bidirectional, so the NO, NC, and COM pins are both inputs or outputs.

Power-Supply Sequencing and Overvoltage Protection

CAUTION: Do not exceed the absolute maximum ratings because stresses beyond the listed ratings may cause permanent damage to devices.

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Proper power-supply sequencing is recommended for all CMOS devices. Always apply V+ before applying analog signals, especially if the analog signal is not current limited. If this sequencing is not possible, and if the analog inputs are not current limited to <20mA, add a small-signal diode (D1) as shown in Figure 1. Adding a protection diode reduces the analog range to a diode drop (about 0.7V) below V+ (for D1). RON increases slightly at low supply voltages. Maximum supply voltage (V+) must not exceed +6V. Protection diode D1 also protects against some overvoltage situations. No damage will result on Figure 1's circuit if the supply voltage is below the absolute maximum rating and if a fault voltage up to the absolute maximum rating is applied to an analog signal pin.

UCSP Package Consideration

For general UCSP package information and PC layout considerations, please refer to the Maxim Application Note (Wafer-Level Ultra-Chip-Board-Scale Package).

UCSP Reliability

The chip-scale package (UCSP) represents a unique packaging form factor that may not perform equally to a packaged product through traditional mechanical reliability tests. CSP reliability is integrally linked to the user's assembly methods, circuit board material, and usage environment. The user should closely review these areas when considering use of a CSP package. Performance through Operating Life Test and Moisture Resistance remains uncompromised as it is primarily determined by the wafer-fabrication process.

Mechanical stress performance is a greater consideration for a CSP package. CSPs are attached through direct solder contact to the user's PC board, foregoing the inherent stress relief of a packaged product lead frame. Solder joint contact integrity must be considered. Information on Maxim's qualification plan, test data, and recommendations are detailed in the UCSP application note, which can be found on Maxim's website at www.maxim-ic.com.

Test Circuits/Timing Diagrams

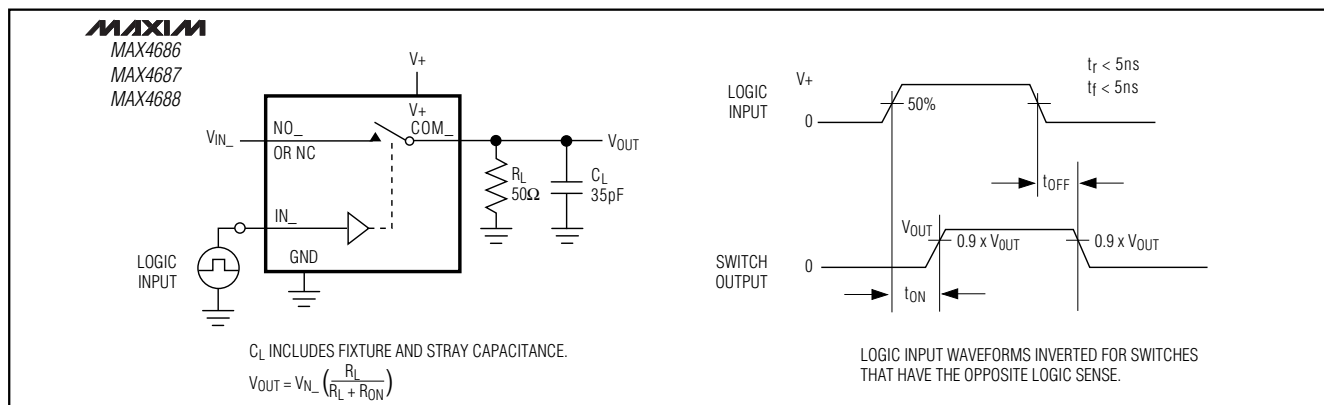


Figure 2. Switching Time

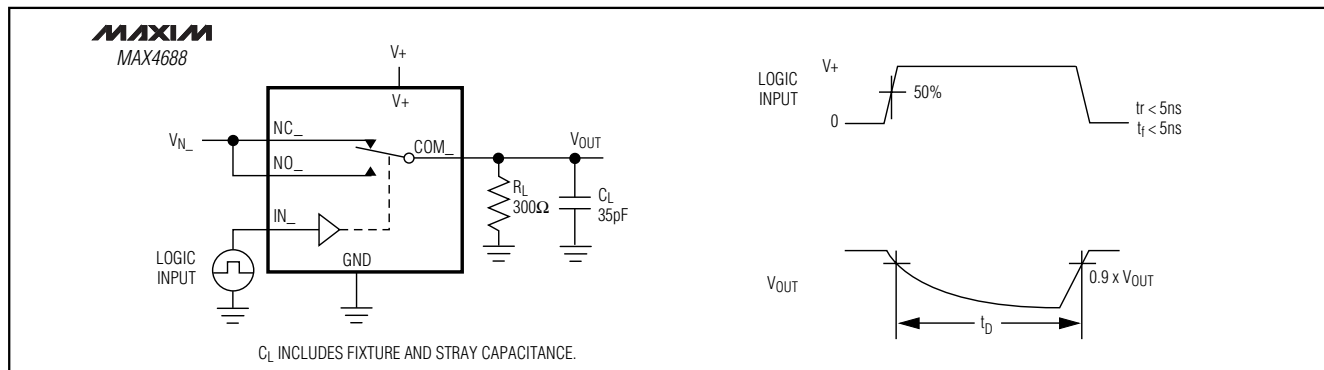


Figure 3. Break-Before-Make Interval (MAX4688 only)

MAX4686/MAX4687/MAX4688

MAXIM
MAX4686
MAX4687
MAX4688

The circuit diagram shows a differential switch configuration. A voltage source V_{GEN} is connected to the NC_ or NO_ input through a resistor R_{GEN} . The COM_ input is connected to the output V_{OUT} and a load capacitor C_L . The IN_ input is connected to a signal source V_{IL} TO V_{IH} . The output V_{OUT} is also connected to a load capacitor C_L . The output voltage V_{OUT} is shown as a step function, with the change in output voltage ΔV_{OUT} indicated. The input signal IN is shown as a square wave, with the output voltage V_{OUT} changing from V_{IL} to V_{IH} when IN is ON, and from V_{IH} to V_{IL} when IN is OFF. The output voltage V_{OUT} is also shown as a step function, with the change in output voltage ΔV_{OUT} indicated.

V_{OUT}

IN OFF ON OFF

IN OFF ON OFF

$Q = (\Delta V_{OUT})(C_L)$

IN DEPENDS ON SWITCH CONFIGURATION;
INPUT POLARITY DETERMINED BY SENSE OF SWITCH.

MEASUREMENTS ARE STANDARDIZED AGAINST SHORTS AT IC TERMINALS.
 OFF-ISOLATION IS MEASURED BETWEEN COM₋ AND "OFF" NO₋ OR NC₋ TERMINAL ON EACH SWITCH.
 ON-LOSS IS MEASURED BETWEEN COM₋ AND "ON" NO₋ OR NC₋ TERMINAL ON EACH SWITCH.
 CROSSTALK IS MEASURED FROM ONE CHANNEL TO ALL OTHER CHANNELS.
 SIGNAL DIRECTION THROUGH SWITCH IS REVERSED; WORST VALUES ARE RECORDED.

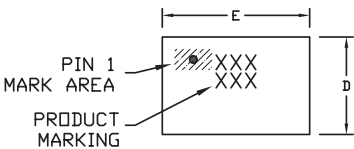
The diagram shows the MAX4686, MAX4687, and MAX4688 capacitance-to-digital converters. The circuit includes a 10nF capacitor connected to the V+ pin and ground. The COM_ pin is connected to a capacitance meter, which is also connected to ground. The NC_ or NO_ pin is connected to ground. The IN pin is connected to the output of a buffer, which is also connected to ground. The output is labeled VIL OR VIH. The frequency f = 1MHz is indicated.

TRANSISTOR COUNT: 150

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Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.

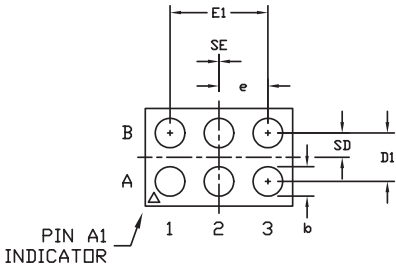


TOP VIEW

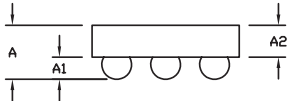
COMMON DIMENSIONS	
A	0.60±0.05
A1	0.27±0.03
A2	0.33 REF.
b	Ø0.37 BASIC
D1	0.50 BASIC
E1	1.00 BASIC
e	0.50 BASIC
SD	0.25 BASIC
SE	0.00 BASIC

PKG. CODE	VARIABLE DIMENSIONS		DEPOPULATED SOLDER BALLS
	D	E	
B6-1	1.00±0.05	1.52±0.05	NONE
B6-2	1.00±0.05	1.52±0.05	B2
B6-3	1.05±0.05	1.57±0.05	NONE
B6-4	1.05±0.05	1.57±0.05	B2
B6-5	0.97±0.05	1.46±0.05	NONE
B6-6	1.16±0.05	1.57±0.05	NONE

- NOTES:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
 2. PRODUCT MARKING: NUMBER OF CHARACTERS AND LINES VARY PER PRODUCT.



BOTTOM VIEW



SIDE VIEW

MAXIM			
PROPRIETARY INFORMATION			
TITLE: PACKAGE OUTLINE, 3x2 UCSP			
APPROVAL	DOCUMENT CONTROL NO. 21-0097	REV. F	1/1

6L, UCSP-EPS

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